Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO220F-2L plastic package, designed for high frequency switched-mode power supplies.

2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I_{FSM}
- · Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- Insulated package rated at 2500V RMS

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{RRM}	repetitive peak reverse voltage			-	-	650	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _h \leq 25 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3; Fig. 4		-	-	10	Α
Tj	junction temperature			-	-	175	°C
Static charac	teristics						
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>		-	1.8	2.1	V
Dynamic characteristics							

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Q _r		$I_F = 10 \text{ A}; dI_F/dt = 500 \text{ A/}\mu\text{s};$ $V_R = 400 \text{ V}; T_i = 25 ^{\circ}\text{C}; Fig. 7$	-	15	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	[_]	K — A
2	А	anode		001aaa020
mb	n.c.	mounting base; isolated	TO220F-2L	

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
NXPSC10650X	-	Plastic single-ended through-hole package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220F	TO220F-2L			

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	650	V
V_{RWM}	crest working reverse voltage		-	650	V
V_R	reverse voltage	DC	-	650	V
I _{F(AV)}	average forward current	δ = 0.5 ; T _h \leq 25 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3; Fig. 4	-	10	Α
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _h ≤ 25 °C; squarewave pulse	-	20	Α
I _{FSM}	non-repetitive peak	t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse	-	50	Α
	forward current	t_p = 10 μ s; $T_{j(init)}$ = 25 °C; square-wave pulse	-	450	Α
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-	175	°C

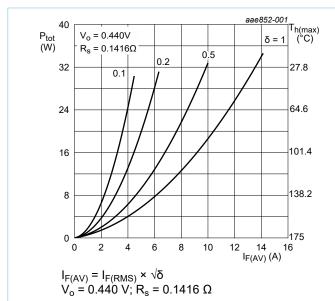


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

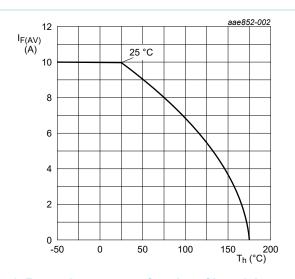
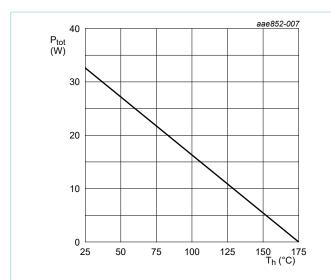


Fig. 2. Forward current as a function of heatsink temperature; maximum values

WeEn Semiconductors NXPSC10650X

Silicon Carbide Diode





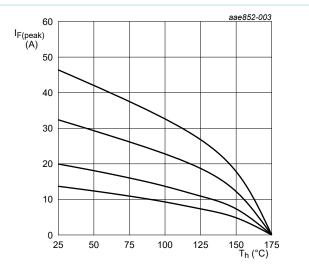


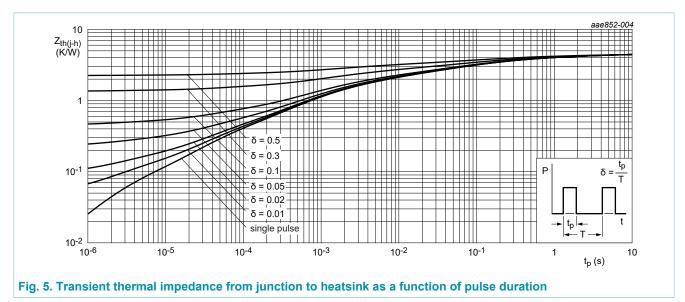
Fig. 4. Current derating as a function of heatsink temperature

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8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	with heatsink compound; Fig. 5	-	-	4.6	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W



9. Isolation characteristics

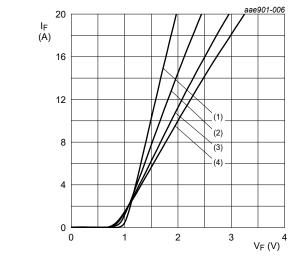
Table 6. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; T _h = 25 °C; RH = 65 %	-	-	2500	V

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	acteristics					
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.8	2.1	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C	-	-	250	μΑ
		V _R = 650 V; T _j = 150 °C	-	-	800	μΑ
Dynamic cl	haracteristics			,		
Q _r	recovered charge	$I_F = 10 \text{ A; } dI_F/dt = 500 \text{ A/}\mu\text{s;}$ $V_R = 400 \text{ V; } T_j = 25 \text{ °C; } Fig. 7$	-	15	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	300	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	34	-	pF
		$f = 1 \text{ MHz}; V_R = 600 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	28	-	pF



(1) T_j = 25 °C; typical values (2) T_j = 100 °C; typical values (3) T_j = 150 °C; typical values (4) T_j = 175 °C; typical values



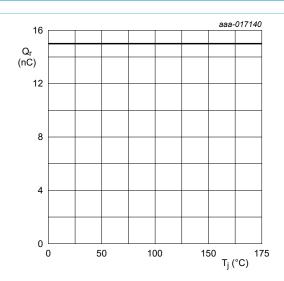


Fig. 7. Recovered charge as a function of junction temperature

11. Package outline

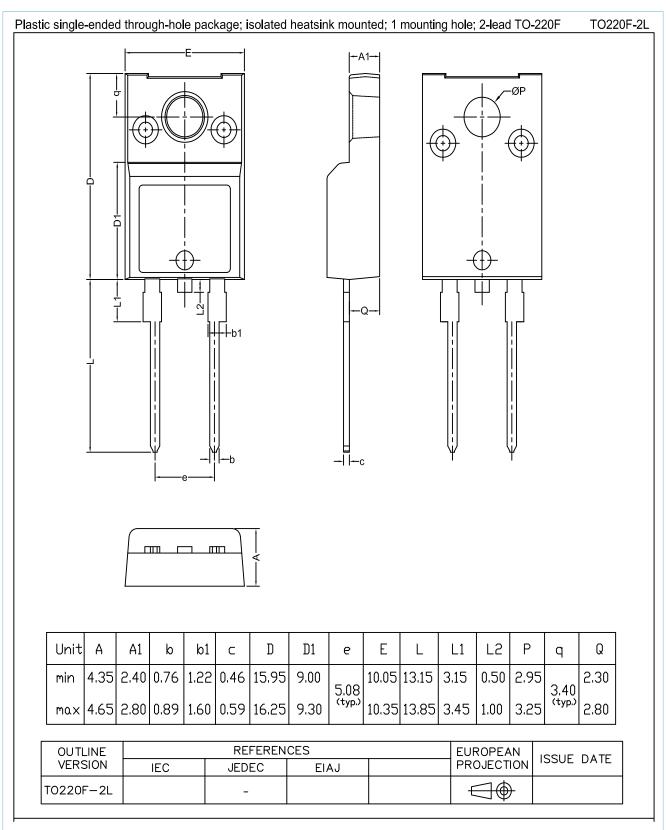


Fig. 8. Package outline TO220F-2L

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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